

# Electric Conductive Pastes for General use

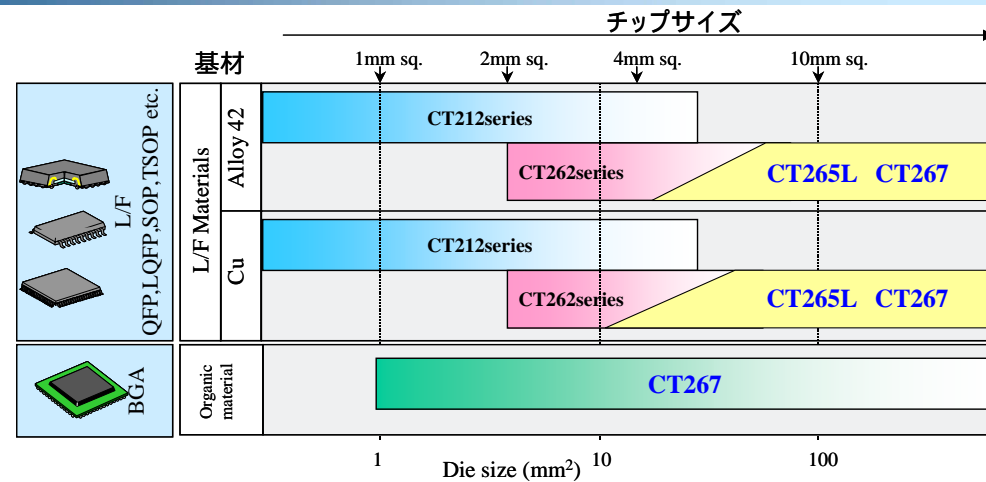
## Paste for bonding various IC

### Feature

- It is an epoxy electro-conductive system adhesive of one liquid type.
- These products will widely correspond to various applications.

### Application

- Various products are collected according to various usages.



## Characteristic Table of Silver Paste CT200 Series

Characteristic Item		CT212H	CT220H S	CT262K	CT267	Test condition
Feature		High adhesive strength	Stamping	In-line cure	Low modulus	-
Liquid Properties	Viscosity (Pa s)	120	50	50	50	EHD type 0.5min -1
	Tixotropic	5.5	5.0	5.5	5.5	0.5 min -1 / 5 min -1
	Ash content (wt%)	74	74	77	73	600 C x 3h
Cured Properties	Tg (oC)	180	110	120	80	DMA
	Modulus (Gpa)	6.5	6.0	6.0	4.0	DMA (25 C)
	CTE (ppm)	50	60	55	60	TMA (Alpa 1)
Cure condition		200 C x 1.5h	150 C x 1h	150 C x 1h	160 C x 1h	Oven cure
Application		SOP	LED	QFP TSOP	BGA	-